41

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

1725

Applicant: Krishna Seshan et al.

Title: A WIRE-BONDABLE PROCESS FLOW COMPATIBLE WITH CU-M6

Docket No.:	884.659US1	Serial No.:	10/052089
Filed:	January 16, 2002	Due Date:	November 19, 2003
Examiner:	Kiley Stoner	Group Art Unit:	1725
Customer No.:	21186	Confirmation No.:	9871

MS Non-Fee Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

We are transmitting herewith the following attached items (as indicated with an "X"):

X   A return postcard.

X   An Amendment and Response Under 37 C.F.R. 1.111 (8 Pages).
If not provided for in a separate paper filed herewith, Please consider this a **PETITION FOR EXTENSION OF TIME for sufficient number of months to enter these papers and please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.**

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.   By: _Ann McCrack_
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(GENERAL)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	Krishna Seshan et al.	Examiner: Kiley Stoner
Serial No.:	10/052089	Group Art Unit: 1725
Filed:	January 16, 2002	Docket No.: 884.659US1
Title:	A WIRE-BONDABLE PROCESS FLOW COMPATIBLE WITH CU-M6	
Assignee:	Intel Corporation	Customer No.: 21186

AMENDMENT AND RESPONSE UNDER 37 CFR § 1.111

MS Non-Fee Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Applicant has reviewed the Office Action mailed on August 19, 2003. Please amend the above-identified patent application as follows.